LMH0001 SMPTE 259M / 344M Serial Digital Cable Driver

Check for Samples: LMH0001

FEATURES

- **SMPTE 259M and SMPTE 344M Compliant**
- **Data Rates to 540 Mbps**
- **Supports DVB-ASI at 270 Mbps**
- **Differential Input**
- **75Ω Differential Output**
- **Adjustable Output Amplitude**
- **Single 3.3V Supply Operation**
- **Industrial Temperature Range: −40°C to +85°C**
- **125mW Typical Power Consumption**
- **16–pin WQFN Package**
- **Footprint Compatible with the LMH0002SQ and the GS9078A.**

APPLICATIONS

- **SMPTE 259M and SMPTE 344M Serial Digital Interfaces**
- **DVB-ASI Applications**
- **Sonet/SDH and ATM Interfaces**
- **Digital Routers and Switches**
- **Distribution Amplifiers**
- **Buffer Applications**
- **Set Top Boxes**
- **Security Cameras**

DESCRIPTION

The LMH0001 SMPTE 259M / 344M Serial Digital Cable Driver is designed for use in SMPTE 259M / 344M serial digital video applications. The LMH0001 drives 75Ω transmission lines (Belden 8281, Belden 1694A or equivalent) at data rates up to 540 Mbps.
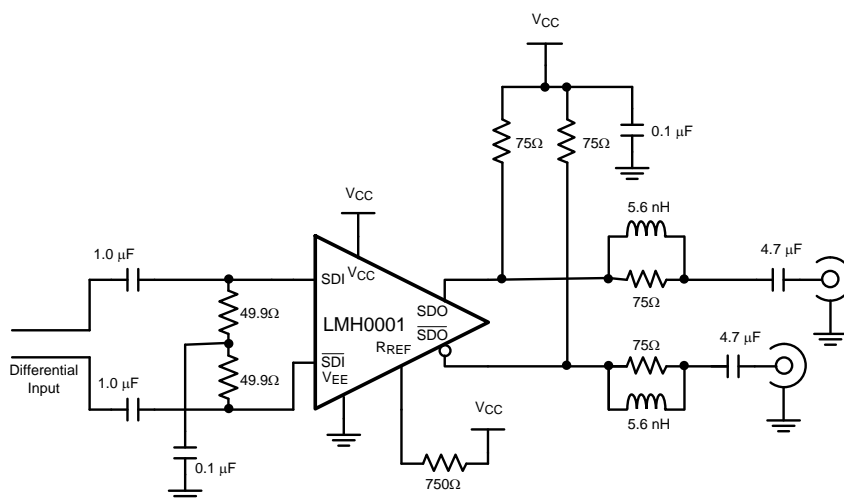
The output voltage swing of the LMH0001 is adjustable via a single external resistor.

The LMH0001 is powered from a single 3.3V supply. Power consumption is typically 125mW. The LMH0001 is available in a 16-pin WQFN package.

Typical Application

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of the Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

Copyright © 2007–2013, Texas Instruments Incorporated

⚠ These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings [1]

Supply Voltage:	−0.5V to 3.6V
Input Voltage (all inputs)	−0.3V to V_{CC}+0.3V
Output Current	28mA
Storage Temperature Range	−65°C to +150°C
Junction Temperature	+150°C
Lead Temperature (Soldering 4 Sec)	+260°C
Package Thermal Resistance θ_{JA} 16-pin WQFN θ_{JC} 16-pin WQFN	+78.9°C/W +42.7°C/W
ESD Rating (HBM)	5kV
ESD Rating (MM)	250V

(1) Absolute Maximum Ratings are those parameter values beyond which the life and operation of the device cannot be ensured. The stating herein of these maximums shall not be construed to imply that the device can or should be operated at or beyond these values. The table of Electrical Characteristics specifies acceptable device operating conditions.

Recommended Operating Conditions

Supply Voltage ($V_{CC} - V_{EE}$):	3.3V ±5%
Operating Free Air Temperature (T_A)	−40°C to +85°C

DC Electrical Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified [1][2].

Parameter		Test Conditions	Reference	Min	Typ	Max	Unit
V_{CMIN}	Input Common Mode Voltage		SDI, $\overline{SDI}$	$1.6 + V_{SDI}/2$		$V_{CC} - V_{SDI}/2$	V
V_{SDI}	Input Voltage Swing	Differential		100		2000	mV_{P-P}
V_{CMOUT}	Output Common Mode Voltage		SDO, $\overline{SDO}$		$V_{CC} - V_{SDO}$		V
V_{SDO}	Output Voltage Swing	Single-ended, 75Ω load, R_{REF} = 750Ω 1%		750	800	850	mV_{P-P}
		Single-ended, 75Ω load, R_{REF} = 590Ω 1%		900	1000	1100	mV_{P-P}
I_{CC}	Supply Current				[3]38	43	mA

(1) Current flow into device pins is defined as positive. Current flow out of device pins is defined as negative. All voltages are stated referenced to V_{EE} = 0 Volts.
(2) Typical values are stated for V_{CC} = +3.3V and T_A = +25°C.
(3) Maximum I_{CC} is measured at V_{CC} = +3.465V and T_A = +70°C.

Product Folder Links: *LMH0001*

AC Electrical Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified [1].

Parameter		Test Conditions	Reference	Min	Typ	Max	Unit
DR_{SDI}	Input Data Rate		[2]SDI, $\overline{SDI}$			540	Mbps
t_{jit}	Additive Jitter	270 Mbps	SDO, $\overline{SDO}$		18		ps_{P-P}
t_r, t_f	Output Rise Time, Fall Time	20% – 80%		400	560	800	ps
	Mismatch in Rise/Fall Time	[2]				30	ps
	Duty Cycle Distortion	[2]				100	ps
t_{OS}	Output Overshoot	[2]				8	%
RL_{SDO}	Output Return Loss			[3]15	20		dB

(1)   Typical values are stated for V_{CC} = +3.3V and T_A = +25°C.
(2)   Specification is ensured by characterization.
(3)   Output return loss is dependent on board design. The LMH0001 meets this specification on the SD001SQ evaluation board from 5MHz to 1.5GHz.
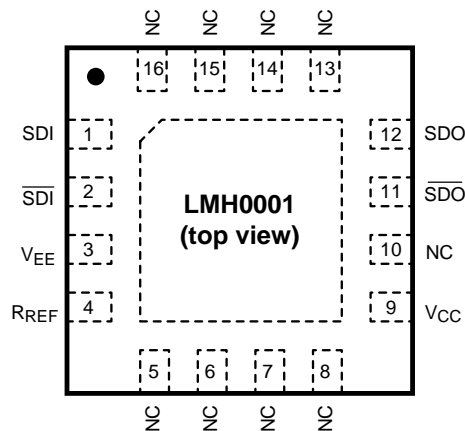
CONNECTION DIAGRAM

Figure 1. 16-Pin WQFN Package
See Package Number RUM0016A

PIN DESCRIPTIONS

SOIC Pin No.	WQFN Pin No.	Name	Description
1	1	SDI	Serial data true input.
2	2	$\overline{SDI}$	Serial data complement input.
3	3	V_{EE}	Negative power supply (ground).
4	4	R_{REF}	Output driver level control. Connect a resistor to V_{CC} to set output voltage swing.
5	9	V_{CC}	Positive power supply (+3.3V).
7	11	$\overline{SDO}$	Serial data complement output.
8	12	SDO	Serial data true output.
—	5, 6, 7, 8, 10, 13, 14, 15, 16	NC	No connect.
—	DAP	V_{EE}	Connect exposed DAP to negative power supply (ground).

DEVICE OPERATION

INPUT INTERFACING

The LMH0001 accepts either differential or single-ended input. The inputs are self-biased, allowing for simple AC or DC coupling. DC-coupled inputs must be kept within the specified common-mode range. SDI and $\overline{\text{SDI}}$ are self-biased at approximately 2.1V with V_{CC} = 3.3V. Figure 2 shows the differential input stage for SDI and $\overline{\text{SDI}}$.
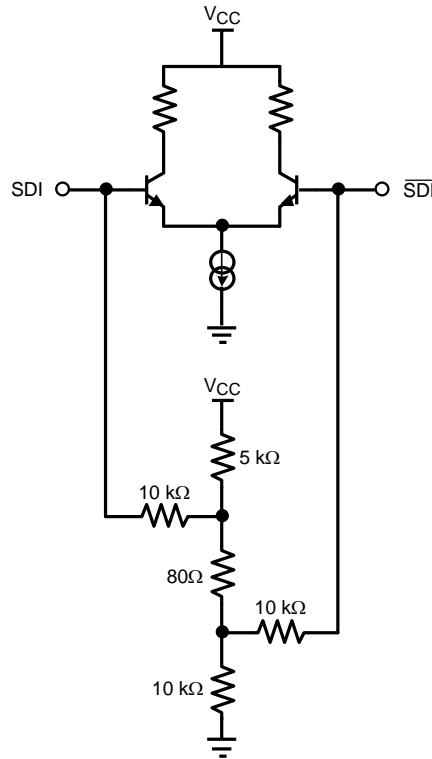

Figure 2. Differential Input Stage for SDI and $\overline{\text{SDI}}$.

OUTPUT INTERFACING

The LMH0001 uses current mode outputs. Single-ended output levels are 800 mV$_{P-P}$ into 75Ω AC-coupled coaxial cable (with R_{REF} = 750Ω). Output level is controlled by the value of the R_{REF} resistor connected between the R_{REF} pin and V_{CC}.

The R_{REF} resistor should be placed as close as possible to the R_{REF} pin. In addition, the copper in the plane layers below the R_{REF} network should be removed to minimize parasitic capacitance.

REVISION HISTORY

Changes from Revision B (April 2013) to Revision C   **Page**

- Changed layout of National Data Sheet to TI format 4

Submit Documentation Feedback   5

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LMH0001SQ/NOPB	ACTIVE	WQFN	RUM	16	1000	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 85	L001	Samples
LMH0001SQE/NOPB	ACTIVE	WQFN	RUM	16	250	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 85	L001	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMH0001SQ/NOPB	WQFN	RUM	16	1000	178.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LMH0001SQE/NOPB	WQFN	RUM	16	250	178.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1

PACKAGE MATERIALS INFORMATION

TAPE AND REEL BOX DIMENSIONS

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMH0001SQ/NOPB	WQFN	RUM	16	1000	210.0	185.0	35.0
LMH0001SQE/NOPB	WQFN	RUM	16	250	210.0	185.0	35.0

RUM0016A

(3.8 TYP)

(□ 2.6)

(12X 0.65)

(16X 0.6)

(16X 0.3)
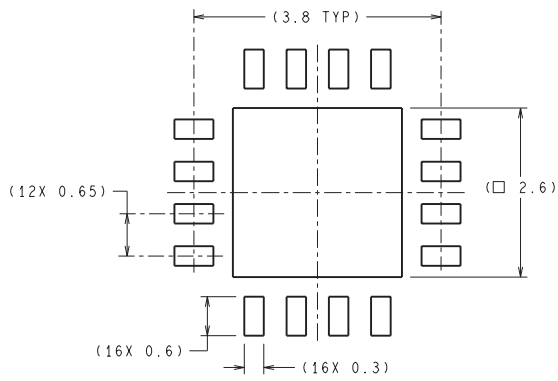
RECOMMENDED LAND PATTERN

DIMENSIONS ARE IN MILLIMETERS
DIMENSIONS IN ( ) FOR REFERENCE ONLY

PIN 1 INDEX AREA

4±0.1

4±0.1

B

A

0.8 MAX

(0.1)

C

(0.1)

PIN 1 ID

□ 2.6±0.1

(45°X0.25)

1   4

5

16

4X 1.95

16X 0.4±0.1   13

8

12   9

16X 0.3±0.05

⊕ 0.1Ⓜ C AⓈ BⓈ

12X 0.65

SQB16A (Rev A)

TEXAS
INSTRUMENTS
www.ti.com
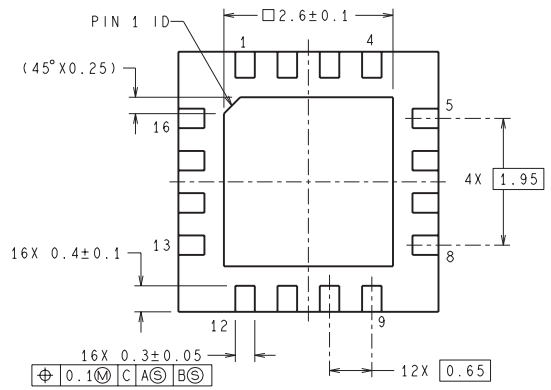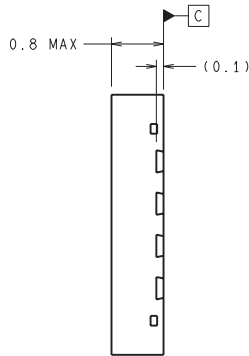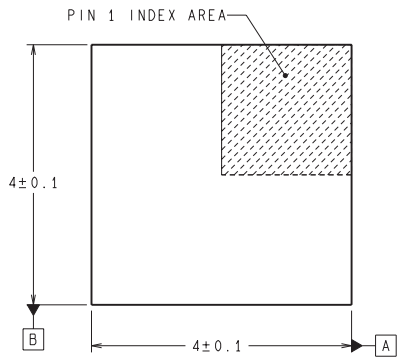
IMPORTANT NOTICE AND DISCLAIMER